RENESAS

μ**PD5902T7K**

CMOS Integrated Circuits High Power SPDT Switch

R09DS0046EJ0200 Rev.2.00 Nov 19, 2012

Data Sheet

DESCRIPTION

The μ PD5902T7K is a CMOS MMIC SPDT (<u>Single Pole Double Throw</u>) switch for GSM and UMTS/LTE main Antenna switching and other High Power RF switching applications up to +35 dBm.

This device can operate frequency from 0.05 to 6.0 GHz, having low insertion loss and high isolation.

This device is housed in a 12-pin plastic QFN (Quad Flat Non-Leaded) (T7K) package.

FEATURES

- Low control voltage : $V_{cont} = 1.3 \text{ V MIN.}, V_{DD} = 2.3 \text{ V MIN.}$
 - Low insertion loss : $L_{ins} = 0.35/0.40 \text{ dB TYP}$. @ f = 1.0/2.0 GHz
- High isolation : ISL = 45/37 dB TYP. @ f = 1.0/2.0 GHz
- High Handling power
- : $P_{in (0.1dB)} = +38 \text{ dBm TYP}$. @f = 0.9/2.0 GHz
- High-density surface mounting : 12-pin plastic QFN (T7K) package $(2.0 \times 2.0 \times 0.6 \text{ mm})$
- No DC blocking capacitors required.

APPLICATIONS

- GSM and UMTS/LTE main Antenna switching etc.
- Other RF switching Applications.
- Antenna tuning Applications.

ORDERING INFORMATION

| Part Number | Order Number | Package | Marking | Supplying Form | |
|---------------|-----------------|--|---------|--|--|
| μPD5902T7K-E2 | μPD5902T7K-E2-A | 12-pin plastic QFN (T7K) (Pb-Free) | 5902 | Embossed tape 8 mm wide Pin 10, 11 and 12 face the perforation side of the tape | |
| | | | | Qty 3 kpcs/reel | |

Remark To order evaluation samples, please contact your nearby sales office. Part number for sample order: μPD5902T7K-A

CAUTION

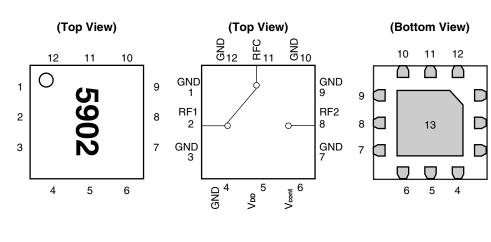
Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.

The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.



<R> PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



| | Pin No. | Pin Name |
|---|---------|-------------------|
| | 1 | GND |
| | 2 | RF1 |
| | 3 | GND |
| | 4 | GND |
| 1 | 5 | V _{DD} |
| 2 | 6 | V _{cont} |
| | 7 | GND |
| 3 | 8 | RF2 |
| | 9 | GND |
| | 10 | GND |
| | 11 | RFC |
| | 12 | GND |
| | 13 | GND |

SW TRUTH TABLE

| V _{cont} | RFC-RF1 | RFC-RF2 |
|-------------------|---------|---------|
| High | ON | OFF |
| Low | OFF | ON |

ABSOLUTE MAXIMUM RATINGS ($T_A = +25^{\circ}C$, unless otherwise specified)

| Parameter | Symbol | Ratings | Unit |
|-------------------------------|-------------------|-------------------------|------|
| Supply Voltage | V _{DD} | 3.6 | V |
| Control Voltage | V _{cont} | 3.6 | V |
| Input Power | Pin | +38 | dBm |
| Operating Ambient Temperature | T _A | <mark>-40</mark> to +85 | °C |
| Storage Temperature | T _{stg} | –55 to +125 | °C |

RECOMMENDED OPERATING RANGE (T_A = +25°C, unless otherwise specified)

| Symbol | MIN. | TYP. | MAX. | Unit |
|----------------------------|--|--|--|---|
| f | 0.05 | - | 6.0 | GHz |
| V _{DD} | 2.3 | - | 3.3 | V |
| V _{cont (H)} Note | 1.3 | - | V_{DD} | V |
| V _{cont (L)} | 0 | - | 0.4 | V |
| | f V _{DD} V _{cont (H)} Note | f 0.05 V _{DD} 2.3 V _{cont (H)} 1.3 | f 0.05 - V _{DD} 2.3 - V _{cont (H)} 1.3 - | f 0.05 - 6.0 V _{DD} 2.3 - 3.3 V _{cont (H)} Note 1.3 - V _{DD} |

Note: $V_{cont} \leq V_{DD}$

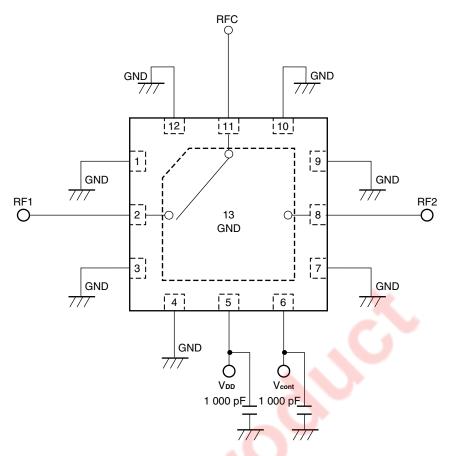


ELECTRICAL CHARACTERISTICS (T_A = +25°C, V_{DD} = 2.5 V, V_{cont (H)} = 1.8 V, V_{cont (L)} = 0 V, Z₀ = 50 Ω , unless otherwise specified)

| I | Parameter | Symbol | Test Conditions | MIN. | TYP. | MAX. | Unit |
|------------|------------------------------|--------------------------|--|-------|---------------|------|------|
| Inse | ertion Loss | L _{ins} 1 | $f = 0.05$ to 0.5 GHz, $P_{in} = 0$ dBm | - | 0.30 | 0.45 | |
| | ĺ | L _{ins} 2 | f = 0.5 to 1.0 GHz | - | 0.35 | 0.50 | |
| | | L _{ins} 3 | f = 1.0 to 2.0 GHz | _ | 0.40 | 0.55 | |
| | | L _{ins} 4 | f = 2.0 to 2.7 GHz | - | 0.45 | 0.75 | |
| | | L _{ins} 5 | f = 2.7 to 3.8 GHz | - | 0.50 | 0.80 | |
| | | L _{ins} 6 | f = 3.8 to 6.0 GHz | - | 0.60 | 0.95 | |
| Isol | lation | ISL1 | $f = 0.05$ to 0.5 GHz, $P_{in} = 0$ dBm | 45 | 50 | _ | |
| (RF | - RF1,2) | ISL2 | f = 0.5 to 1.0 GHz | 40 | 45 | _ | |
| | | ISL3 | f = 1.0 to 2.0 GHz | 32 | 37 | _ | dB |
| | | ISL4 | f = 2.0 to 2.7 GHz | 30 | 35 | _ | |
| | | ISL5 | f = 2.7 to 3.8 GHz | 25 | 30 | _ | - |
| | Ì | ISL6 | f = 3.8 to 6.0 GHz | _ | 23 | _ | |
| Ret | turn Loss | RL1 | f = 0.05 to 3.8 GHz | 15 | 18 | _ | - |
| (RF | -C) | RL2 | f = 3.8 to 6.0 GHz | _ | 15 | _ | |
| Ret | turn Loss | RL1 | f = 0.05 to 3.8 GHz | 15 | 18 | - 1 | |
| | 1,2) | RL2 | f = 3.8 to 6.0 GHz | - | 15 | _ | |
| | dB Loss mpression | $P_{in(0.1dB)}$ 1 | f = 0.9 GHz | +36.0 | +38.0 Note | _ | |
| | ut Power | P _{in(0.1dB)} 2 | f = 2.0 GHz | +36.0 | +38.0 Note | _ | dBm |
| Har | rmonics | 2f0 | f = 0.9 GHz, P _{in} = +35 dBm | 75 | 80 | _ | |
| | | 3f0 | | 70 | 75 | _ | 1 |
| | ľ | 2f0 | f = 2.0 GHz, P _{in} = +33 dBm | 75 | 85 | _ | dBc |
| | | 3f0 | - | 70 | 80 | _ | - |
| Mo | d Order Inter dulation | | f = 835 MHz, P _{in} = +20 dBm f = 45 MHz, P _{in} = -15 dBm | _ | -98 | -93 | |
| Dis | tortion | IMD2 | f = 1 950 MHz, P _{in} = +20 dBm f = 190MHz, P _{in} = -15 dBm | _ | -105 | -100 | dBm |
| Mo | Order Inter dulation | IMD3 | $f = 835 \text{ MHz}, P_{in} = +20 \text{ dBm}$ $f = 790 \text{ MHz}, P_{in} = -15 \text{ dBm}$ | _ | -110 | -105 | dDin |
| Dis | tortion | INDS | f = 1 950 MHz, P _{in} = +20 dBm f = 1 760 MHz, P _{in} = -15 dBm | _ | -110 | -105 | |
| | ut 3rd order ercept Point | IIP ₃ | f = 2 500 MHz, P _{in} = +20 dBm f = 2 501 MHz, P _{in} = +20 dBm | 65 | 70 | _ | dBm |
| Swi Spe | itch Control eed | T_{sw} | 50% CTL to 90/10% | _ | 2.0 | 5.0 | µsec |
| Sup | oply Current | I _{DD} | Active Mode No RF | - | 130 | 250 | |
| Cor | ntrol Current | I _{cont} (H) | V _{cont} : High No RF | - | - | 1 | μA |
| | - | | V _{cont} : Low No RF | | | | ٦ |

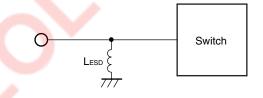
Note: Absolute Maximum Ratings

<R> EVALUATION CIRCUIT



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

APPLICATION INFORMATION

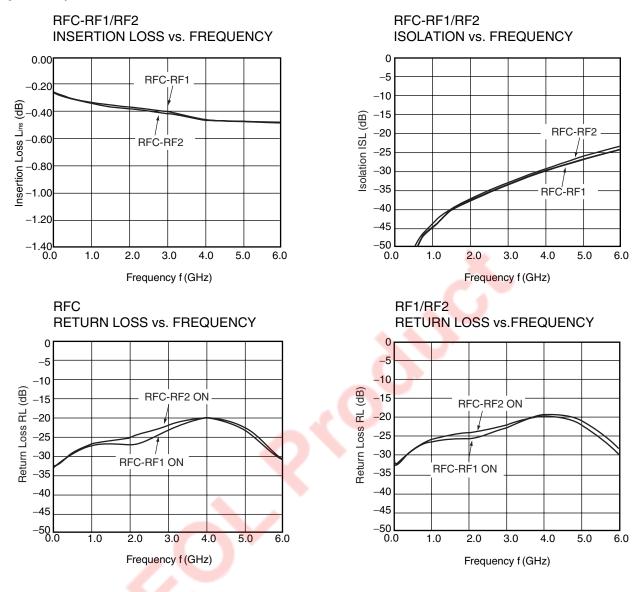


• L_{ESD} provides a means to increase the ESD protection on a specific RF port, typically the port attached to the antenna.



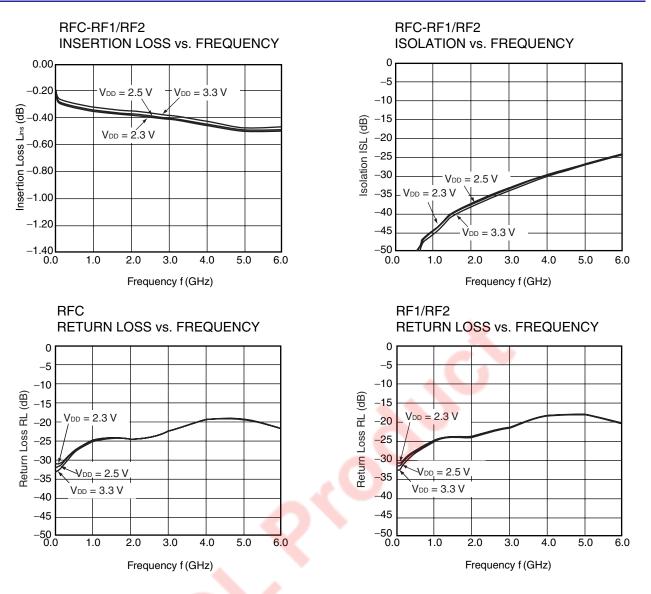
TYPICAL CHARACTERISTICS

(T_A = +25°C, V_{DD} = 2.5 V, V_{cont (H)} = 1.8 V, V_{cont (L)} = 0 V, Z₀ = 50 Ω , unless otherwise specified)



Remark The graphs indicate nominal characteristics.

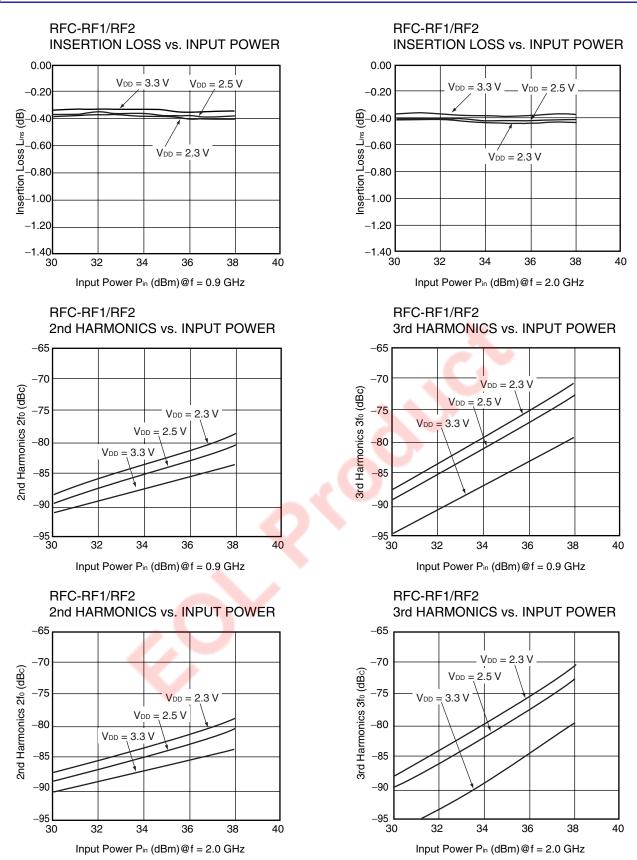




Remark The graphs indicate nominal characteristics.

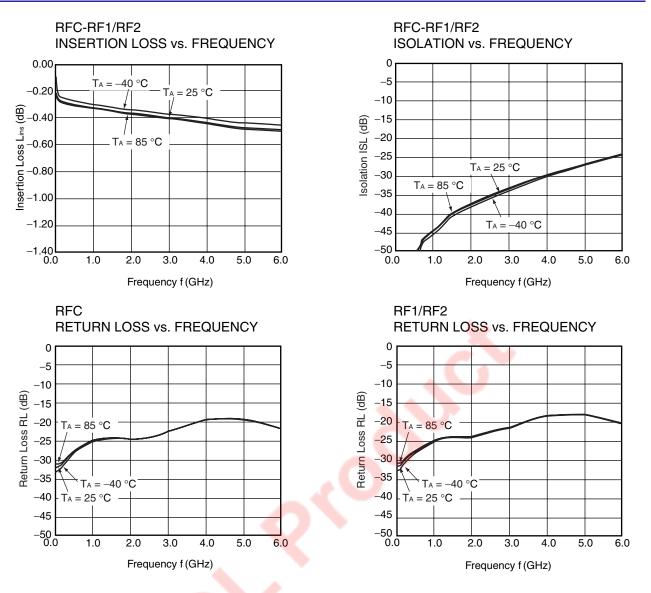
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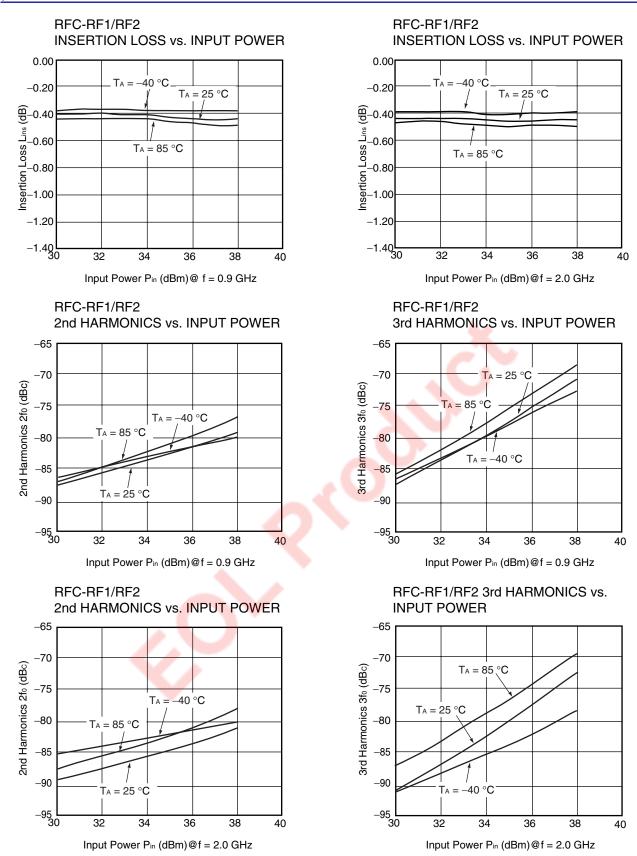


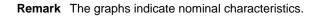




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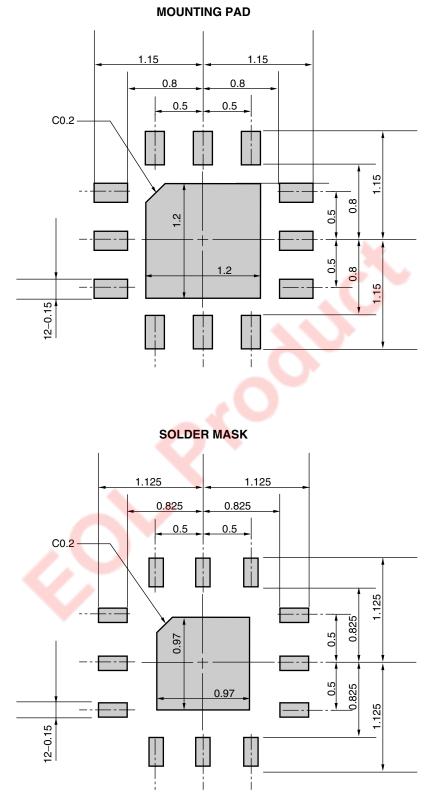






MOUNTING PAD LAYOUT DIMENSIONS

12-PIN PLASTIC QFN (T7K) (UNIT: mm)



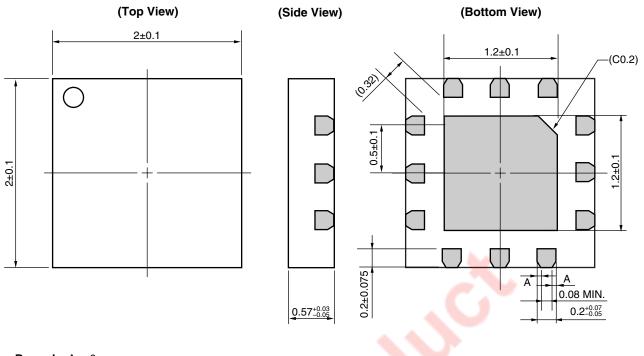
Solder thickness : 0.1 mm

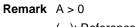
Remark The mounting pad layout in this document is for reference only.When designing PCB, please consider workability of mounting, solder joint reliability, prevention of solder bridge and so on, in order to optimize the design.



PACKAGE DIMENSIONS

12-PIN PLASTIC QFN (T7K) (UNIT: mm)





(): Reference value



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

| Soldering Method | Soldering Conditions | | Condition Symbol |
|------------------|---|-----------------------|------------------|
| Infrared Reflow | Peak temperature (package surface temperature) | : 260°C or below | IR260 |
| | Time at peak temperature | : 10 seconds or less | |
| | Time at temperature of 220°C or higher | : 60 seconds or less | |
| | Preheating time at 120 to 180°C | : 120±30 seconds | |
| | Maximum number of reflow processes | : 3 times | |
| | Maximum chlorine content of rosin flux (% mass) | : 0.2% (Wt.) or below | |
| Partial Heating | Peak temperature (terminal temperature) | : 350°C or below | HS350 |
| | Soldering time (per side of device) | : 3 seconds or less | |
| | Maximum chlorine content of rosin flux (% mass) | : 0.2% (Wt.) or below | |

CAUTION

Do not use different soldering methods together (except for partial heating).



Revision History

μ PD5902T7K Data Sheet

| | | Description | | |
|------|--------------|-------------|--|--|
| Rev. | Date | Page | Summary | |
| 1.00 | Sep 10, 2012 | - | First edition issued | |
| 2.00 | Nov 19, 2012 | p.2 | p.2 The block diagram is changed. | |
| | | p.3 | The symbol indicating the range between terminals is changed from "to" to "-". | |
| | | p.4 | The evaluation circuit is changed. | |

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